

# PRODUCT SPECIFICATION

DOCUMENT NO. ENS000109590							
DESCRIPTION DRAWN BY DESIGNED BY CHECKED BY APPROVED BY							
MLVS2220 AMDG Series Sandy Joesing Ho Shawn Yeh Shawn Yeh							



# **MLVS2220 AMDG Series Engineering Specification**

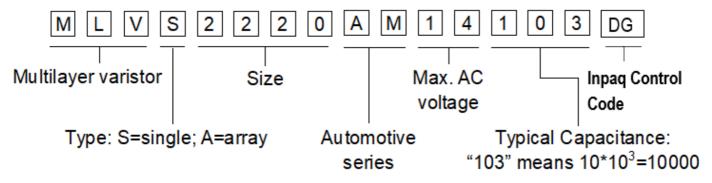
## 1. Scope

- (1) Qualified based on AEC-Q200
- (2) Meet IEC 61000-4-5 standard
- (3) RoHS compliant
- (4) Insulator over coat keeps excellent low and stable leakage current
- (5) Quick response time (<1ns)
- (6) Low clamping voltage
- (7) High transient current capability
- (8) High reliability
- (9) Compact size for EIA2220

# **Applications**

Protection against automotive related transient overvoltage

## 2. Explanation of Part Number



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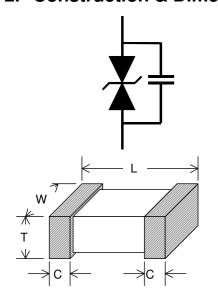
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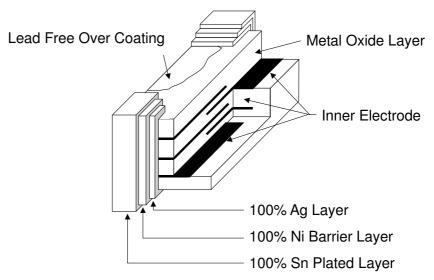
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# 2. Construction & Dimension



В



Unit: mm	2220
L	5.70±0.4
W	5.20±0.4
Т	3.0 Max./4.0 Max.
С	1.4 Max

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## 3. Part ratings and characteristics

3.1. Ratings (25°C for characteristics, 125°C for maximum ratings)

	Working voltage		Varistor voltage	Clamping Voltage	Capacitance	Peak current	
Symbol	$V_{RMS}$	$V_{DC}$	$V_{V}$	Vc	Ср	i <sub>max</sub>	
Units	Volts	Volts	Volts	Volts	pF	Amps	
Units	(Max.)	(Max.)	VOILS	(Max.)	(Typical)	(Max.)	
Test Condition		< 50 μΑ	1mA DC	10A 8/20μs	1KHz	8/20μs (1Time)	
MLVS2220AM14103DG	14	16	21.4~27.8	55	10000 150		
MLVS2220AM14193DG	14	16	21.4~27.9	55	55 19000 4		
MLVS2220AM14273DG	14	16	21.4~27.9	55	27000	5000	
MLVS2220AM30382DG	30	38	42.3~51.7	77	3800	1200	
MLVS2220AM50692DG	50	63	69.3~84.7	115	6900	4500	
MLVS2220AM50192DG	50	65	73.8~90.2	135	1900	800	
MLVS2220AM50652DG	50	65	73.8~90.2	140	6500	4500	
MLVS2220AM60102DG	60	85	90~110 165 1000		1000	800	

V<sub>RMS</sub> – Maximum AC operating voltage the varistor can maintain and not exceed 50μA leakage current

V<sub>DC</sub> – Maximum DC operating voltage the varistor can maintain and not exceed 50μA leakage current

V<sub>V</sub>-Voltage across the device measured at 1mA DC current. Equivlent to Vb, "Breakdown Voltage".

Vc – Maximum peak voltage across the varistor measured at 8/20us waveform

Cp – Device capacitance measured with zero volt bias 1Vrms.

i<sub>max</sub> – Maximum peak current which may be applied with 8/20us waveform without device failure

8/20us: Calibration method by short circuit

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# 4. General electrical specifications

#### 4.1. General technical data

Operating temperature	-40 +125°C			
Storage temperature (on board)	-40 +125°C			
Response time	<1 ns			
Solderability	245±5°C, 5 +0/-0.5sec			
Solder leach resistance	260±5°C,10 ±1sec			

## 4.2. Taping Package Storage Condition

Storage Time: 12 months max. Storage Temperature: 5 to 40°C Relative Humidity: 65% max.

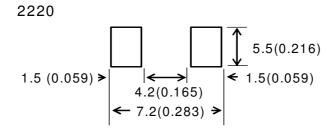
# 5. Precautions for Handling

#### 5.1. Solder cream in reflow soldering

Refer to the recommendable land pattern as printing mask pattern for solder cream.

(1) Print solder in a thickness of 150 to 200  $\mu m$ 

Dimensions: millimeters (inches)



#### 5.2. Precaution for handling of substrate

Do not exceed to bend the board after soldering this product extremely. (Reference examples)

- Mounting place must be as far as possible from the position, which is close to the break line of board, or on the line of large holes of board.
- Do not bend extremely the board, in mounting another component.

  If necessary, use back-up pin (support pin) to prevent from bending extremely.
- Do not break the board by hand. We recommend using the machine or the jig to break it.

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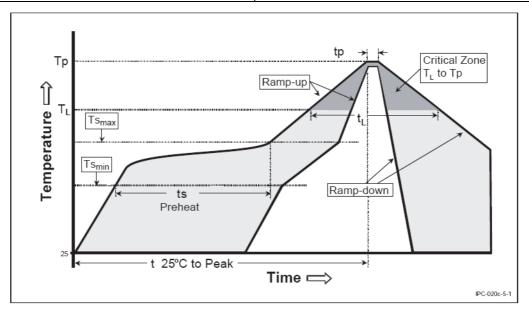
## 5.3. Precaution for soldering

Note that rapid heating, rapid cooling or local heating will easily damage the component.

Do not give heat shock over 100°C in the process of soldering. We recommend taking preheating and gradual cooling.

## 5.4. Recommendable reflow soldering

Profile Feature	Pb-Free Assembly		
Average Ramp-Up Rate	3°C/second max.		
(Tsmax to Tp)			
Preheat			
<ul><li>– Temperature Min (Tsmin)</li></ul>	150℃		
<ul><li>– Temperature Max (Tsmax)</li></ul>	200℃		
<ul><li>Time (tsmin to tsmax)</li></ul>	60-180 seconds		
Time maintained above:			
<ul><li>– Temperature (TL)</li></ul>	217℃		
– Time (tL)	60-150 seconds		
Peak/Classification Temperature (Tp)	260℃		
Time within 5 °C of actual Peak	20-40 seconds		
Temperature (tp)			
Ramp-Down Rate	6°C/second max.		
Time 25 ℃ to Peak Temperature	8 minutes max.		



<sup>\*</sup>According to J-STD-020C

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#### 5.5. Solder gun procedure

Note the follows, in case of using solder gun for replacement.

- (1) Use solder tip temperature must be less than 350°C for the period within 3 seconds by using soldering gun under 30W.
- (2) Soldering gun tip shall not touch component directly.

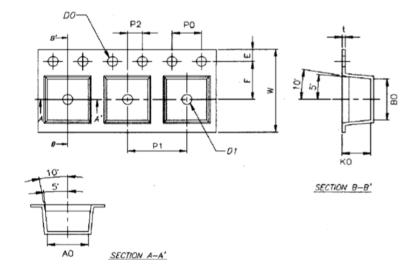
## 5.6. Soldering volume

Apply proper volume of solder paste, too much may cause crack of component body.

# 6. Taping Package and Label Marking

## 6.1. Carrier tape dimensions

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**Unit:mm** 

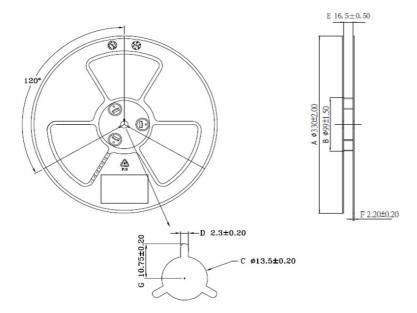
Туре	W	E	F	D0		D1	P0	P1	P2	P0 x10
	12.00	1.75	5.5	1.5		1.5	4.00	8.00	2.00	40.00
	±0.30	±0.10	±0.05	+0.10	/-0.00	+0.10/-0.00	±0.10	±0.10	±0.05	±0.20
2220	t	Α0	В0	K0						
	0.40	5.45	5.95	3.20	4.10					
	±0.05	±0.05	±0.05	±0.10	±0.10					

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#### 6.2. Taping reel dimensions



А	330±2.00
В	99±1.50
С	13.5±0.20
D	2.3±0.20
Е	16.5±0.50
F	2.2±0.20
G	10.75±0.20

## 6.3. Taping specifications

There shall be the portion having no product in both the head and the end of taping, and there shall be the cover tape in the head of taping.

## 6.4. Label Marking

The label specified as follows shall be put on the side of reel.

- (1) Part No.
- (2) Quantity
- (3) Lot No.

Part No. And Quantity shall be marked on outer packaging.

## 6.5. Quantity of products in the taping package

- (1) Standard quantity: 2,000pcs/Reel
- (2) Shipping quantity is a multiple of standard quantity.

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